# Low Voltage Single Supply SPDT Analog Switch

The NLAST4599 is an advanced high speed CMOS single pole – double throw analog switch fabricated with silicon gate CMOS technology. It achieves high speed propagation delays and low ON resistances while maintaining low power dissipation. This switch controls analog and digital voltages that may vary across the full power–supply range (from  $V_{CC}$  to GND).

The device has been designed so the ON resistance  $(R_{ON})$  is much lower and more linear over input voltage than  $R_{ON}$  of typical CMOS analog switches.

The channel select input structure provides protection when voltages between 0 V and 5.5 V are applied, regardless of the supply voltage. This input structure helps prevent device destruction caused by supply voltage – input/output voltage mismatch, battery backup, hot insertion, etc.

#### **Features**

- Select Pin Compatible with TTL Levels
- Channel Select Input Over-Voltage Tolerant to 5.5 V
- Fast Switching and Propagation Speeds
- Break-Before-Make Circuitry
- Low Power Dissipation:  $I_{CC} = 2 \mu A$  (Max) at  $T_A = 25^{\circ}C$
- Diode Protection Provided on Channel Select Input
- Improved Linearity and Lower ON Resistance over Input Voltage
- Latch-up Performance Exceeds 300 mA
- ESD Performance: HBM > 2000 V; MM > 200 V
- Chip Complexity: 38 FETs
- Pb-Free Packages are Available

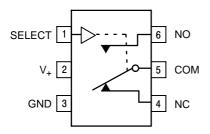


Figure 1. Pin Assignment

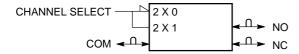


Figure 2. Logic Symbol



#### ON Semiconductor®

http://onsemi.com

#### MARKING DIAGRAMS



TSOP-6 DT SUFFIX CASE 318G







A1 = Specific Device Code

A = Assembly Location

Y = Year

W = Work Week

M = Date Code\*

■ = Pb–Free Package

(Note: Microdot may be in either location)
\*Date Code orientation and/or position and underbar
may vary depending upon manufacturing location.

#### **FUNCTION TABLE**

Select	ON Channel
L	NC
Н	NO

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

#### **MAXIMUM RATINGS** (Note 1)

	Parameter	Symbol	Value	Unit
Positive DC Supply Volta	age	V <sub>CC</sub>	-0.5 to +7.0	V
Analog Input Voltage (V <sub>N</sub>	<sub>IO</sub> or V <sub>COM</sub> )	V <sub>IS</sub>	$-0.5 \le V_{IS} \le V_{CC} + 0.5$	V
Digital Select Input Volta	ge	$V_{IN}$	$-0.5 \le V_1 \le +7.0$	V
DC Current, Into or Out of	of Any Pin	I <sub>IK</sub>	±50	mA
Power Dissipation in Still	Air SC-88 TSOP6	$P_{D}$	200 200	mW
Storage Temperature Ra	nge	T <sub>STG</sub>	-65 to +150	°C
Lead Temperature, 1mm	from Case for 10 seconds	T <sub>L</sub>	260	°C
Junction Temperature Ur	nder Bias	TJ	150	°C
ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	V <sub>ESD</sub>	2000 200 N/A	V
Latchup Performance	Above V <sub>CC</sub> and Below GND at 125°C (Note 5)	I <sub>LATCHUP</sub>	±300	mA
Thermal Resistance	SC-88 TSOP6	$\theta_{\sf JA}$	333 333	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.
- 2. Tested to EIA/JESD22-A114-A
- 3. Tested to EIA/JESD22-A115-A
- 4. Tested to JESD22-C101-A
- 5. Tested to EIA/JESD78

#### **RECOMMENDED OPERATING CONDITIONS**

Characteristics	Symbol	Min	Max	Unit
DC Supply Voltage	V <sub>CC</sub>	2.0	5.5	V
Digital Select Input Voltage	V <sub>IN</sub>	GND	5.5	V
Analog Input Voltage (NC, NO, COM)	V <sub>IS</sub>	GND	V <sub>CC</sub>	V
Operating Temperature Range	T <sub>A</sub>	-55	+125	°C
Input Rise or Fall Time SELECT $ \begin{array}{c} \text{V}_{\text{CC}} = 3.3 \text{ V} \pm 0.3 \text{ V} \\ \text{V}_{\text{CC}} = 5.0 \text{ V} \pm 0.5 \text{ V} \end{array} $	t <sub>r</sub> , t <sub>f</sub>	0	100 20	ns/V

## DEVICE JUNCTION TEMPERATURE VERSUS TIME TO 0.1% BOND FAILURES

Junction Temperature °C	Time, Hours	Time, Years
80	1,032,200	117.8
90	419,300	47.9
100	178,700	20.4
110	79,600	9.4
120	37,000	4.2
130	17,800	2.0
140	8,900	1.0

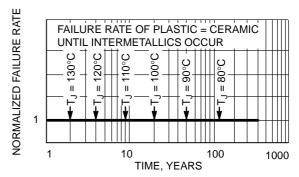


Figure 3. Failure Rate vs. Time Junction Temperature

#### DC CHARACTERISTICS - Digital Section (Voltages Referenced to GND)

		Guaranteed Limit				iit	
Parameter	Condition	Symbol	V <sub>CC</sub>	-55 to 25°C	<85°C	<125°C	Unit
Minimum High-Level Input Voltage, Select Input		V <sub>IH</sub>	3.0 4.5 5.5	2.0 2.0 2.0	2.0 2.0 2.0	2.0 2.0 2.0	V
Maximum Low–Level Input Voltage, Select Input		V <sub>IL</sub>	3.0 4.5 5.5	0.5 0.8 0.8	0.5 0.8 0.8	0.5 0.8 0.8	V
Maximum Input Leakage Current, Select Input	V <sub>IN</sub> = 5.5 V or GND	I <sub>IN</sub>	5.5	<u>+</u> 0.1	<u>+</u> 1.0	<u>+</u> 1.0	μΑ
Power Off Leakage Current	V <sub>IN</sub> = 5.5 V or GND	I <sub>OFF</sub>	0	<u>+</u> 10	<u>+</u> 10	<u>+</u> 10	μΑ
Maximum Quiescent Supply Current	Select and V <sub>IS</sub> = V <sub>CC</sub> or GND	Icc	5.5	1.0	1.0	2.0	μΑ

#### DC ELECTRICAL CHARACTERISTICS - Analog Section

				Guaranteed Limit			
Parameter	Condition	Symbol	V <sub>CC</sub>	-55 to 25°C	<85°C	<125°C	Unit
Maximum "ON" Resistance (Figures 17 – 23)	$\begin{split} &V_{IN} = V_{IL} \text{ or } V_{IH} \\ &V_{IS} = \text{GND to } V_{CC} \\ &I_{IN}I \leq 10.0 \text{ mA} \end{split}$	R <sub>ON</sub>	2.5 3.0 4.5 5.5	85 45 30 25	95 50 35 30	105 55 40 35	Ω
ON Resistance Flatness (Figures 17 – 23)	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{IN}I \le 10.0 \text{ mA}$ $V_{IS} = 1V, 2V, 3.5V$	R <sub>FLAT</sub> (ON)	4.5	4	4	5	Ω
ON Resistance Match Between Channels	$\begin{split} &V_{IN} = V_{IL} \text{ or } V_{IH} \\ &I_{IN}I \leq 10.0 \text{ mA} \\ &V_{NO} \text{ or } V_{NC} = 3.5 \text{ V} \end{split}$	ΔR <sub>ON</sub> (ON)	4.5	2	2	3	Ω
NO or NC Off Leakage Current (Figure 9)	$V_{IN} = V_{IL}$ or $V_{IH}$ $V_{NO}$ or $V_{NC} = 1.0$ $V_{COM}$ 4.5 $V$	I <sub>NC(OFF)</sub> I <sub>NO(OFF)</sub>	5.5	1	10	100	nA
COM ON Leakage Current (Figure 9)	$\begin{split} &V_{IN} = V_{IL} \text{ or } V_{IH} \\ &V_{NO} \text{ 1.0 V or 4.5 V with } V_{NC} \text{ floating or} \\ &v_{NO} \text{ 1.0 V or 4.5 V with } V_{NO} \text{ floating } \\ &V_{COM} = \text{ 1.0 V or 4.5 V} \end{split}$	I <sub>COM(ON)</sub>	5.5	1	10	100	nA

#### AC ELECTRICAL CHARACTERISTICS (Input $t_f = t_f = 3.0 \text{ ns}$ )

					G	uarant	teed M	ax Lin	nit			
			v <sub>cc</sub>	VIS	-5	5 to 25	s°C	<8	5°C	<12	25°C	
Parameter	Test Conditions	Symbol	(V)	(V)	Min	Тур*	Max	Min	Max	Min	Max	Unit
Turn-On Time	$R_L = 300 \Omega, C_L = 35 pF$	t <sub>ON</sub>	2.5	2.0	5	23	28	5	30	5	30	ns
(Figures 12 and 13)	(Figures 5 and 6)		3.0	2.0	5	16	21	5	25	5	25	
			4.5	3.0	2	11	16	2	20	2	20	
			5.5	3.0	2	9	14	2	20	2	20	
Turn-Off Time	$R_L = 300 \Omega, C_L = 35 pF$	t <sub>OFF</sub>	2.5	2.0	1	7	12	1	15	1	15	ns
(Figures 12 and 13)	(Figures 5 and 6)		3.0	2.0	1	5	10	1	15	1	15	
			4.5	3.0	1	4	9	1	12	1	12	
			5.5	3.0	1	3	8	1	12	1	12	
Minimum Break-Before-	V <sub>IS</sub> = 3.0 V (Figure 4)	t <sub>BBM</sub>	2.5	2.0	1	12		1		1		ns
Make Time	$R_L = 300 \Omega, C_L = 35 pF$		3.0	2.0	1	11		1		1		
			4.5	3.0	1	6		1		1		
			5.5	3.0	1	5		1		1		
				•	Тур	oical @	25, VC	CC = 5	.0 V	•		
Maximum Input Capacitance Analog I/O (switch off) Common I/O (switch off) Feedthrough (switch on)	e, Select Input	C <sub>IN</sub> C <sub>NO</sub> or C <sub>NC</sub> C <sub>COM</sub> C <sub>(ON)</sub>	8 10 10 20			pF						

<sup>\*</sup>Typical Characteristics are at 25  $^{\circ}\text{C}.$ 

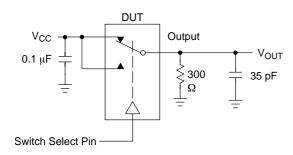
#### ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)

Parameter	Condition	Symbol	V <sub>CC</sub> V	Typical 25°C	Unit
Maximum On–Channel –3dB Bandwidth or Minimum Frequency Response (Figure 10)	V <sub>IN</sub> = 0 dBm V <sub>IN</sub> centered between V <sub>CC</sub> and GND (Figure 7)	BW	3.0 4.5 5.5	170 200 200	MHz
Maximum Feedthrough On Loss	V <sub>IN</sub> = 0 dBm @ 100 kHz to 50 MHz V <sub>IN</sub> centered between V <sub>CC</sub> and GND (Figure 7)	V <sub>ONL</sub>	3.0 4.5 5.5	-2 -2 -2	dB
Off–Channel Isolation (Figure 10)		V <sub>ISO</sub>	3.0 4.5 5.5	-93 -93 -93	dB
Charge Injection Select Input to Common I/O (Figure 15)	$\begin{aligned} &V_{IN} = V_{CC~to}~GND,~F_{IS} = 20~kHz\\ &t_r = t_f = 3~ns\\ &R_{IS} = 0~\Omega,~C_L = 1000~pF\\ &Q = C_L * \Delta V_{OUT,}~(Figure~8) \end{aligned}$	Q	3.0 5.5	1.5 3.0	рС
Total Harmonic Distortion THD + Noise (Figure 14)	$F_{IS}$ = 20 Hz to 100 kHz, $R_L$ = Rgen = 600 Ω, $C_L$ = 50 pF $V_{IS}$ = 5.0 $V_{PP}$ sine wave	THD	5.5	0.1	%

#### **ORDERING INFORMATION**

		Devic	e Nomencla	ture			
Device	Circuit Indicator	Technology	Device Function	Package Suffix	Tape & Reel Suffix	Package	Shipping <sup>†</sup>
NLAST4599DFT2						SC-88/SC-70/SOT-363	
NLAST4599DFT2G	NII	46	4500	DF	T2	SC-88/SC-70/SOT-363 (Pb-Free)	2000/Tong % Dool
NLAST4599DTT1	NL	AS	4599			TSOP-6	3000/Tape & Reel
NLAST4599DTT1G				DT	T1	TSOP-6 (Pb-Free)	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



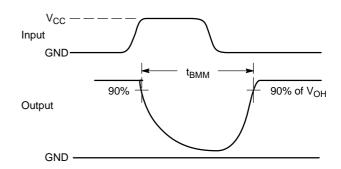
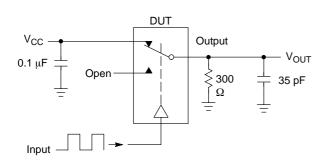


Figure 4. t<sub>BBM</sub> (Time Break-Before-Make)



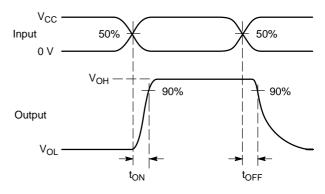
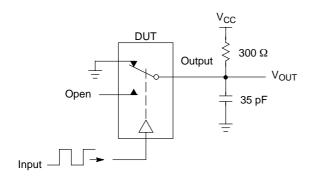


Figure 5. t<sub>ON</sub>/t<sub>OFF</sub>



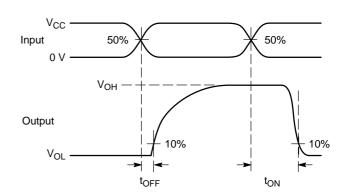
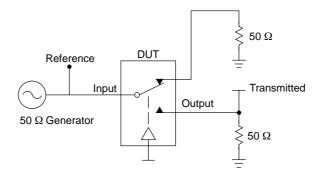


Figure 6. t<sub>ON</sub>/t<sub>OFF</sub>



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch.  $V_{\rm ISO}$ , Bandwidth and  $V_{\rm ONL}$  are independent of the input signal direction.

$$V_{ISO}$$
 = Off Channel Isolation = 20 Log  $\left(\frac{V_{OUT}}{V_{IN}}\right)$  for  $V_{IN}$  at 100 kHz

$$V_{ONL}$$
 = On Channel Loss = 20 Log  $\left(\frac{V_{OUT}}{V_{IN}}\right)$  for  $V_{IN}$  at 100 kHz to 50 MHz

Bandwidth (BW) = the frequency 3 dB below V<sub>ONL</sub>

Figure 7. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/V<sub>ONL</sub>

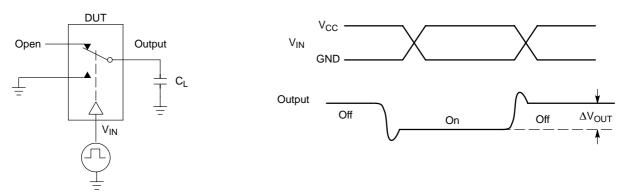


Figure 8. Charge Injection: (Q)

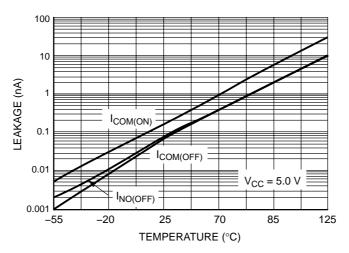
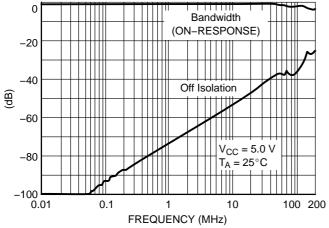


Figure 9. Switch Leakage vs. Temperature

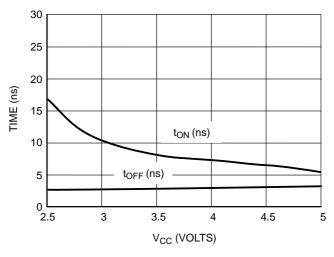
0



10 WY Ha 30 V<sub>CC</sub> = 5.0 V T<sub>A</sub> = 25°C 0.01 0.1 1 10 100 200 FREQUENCY (MHz)

Figure 10. Bandwidth and Off-Channel Isolation

Figure 11. Phase vs. Frequency



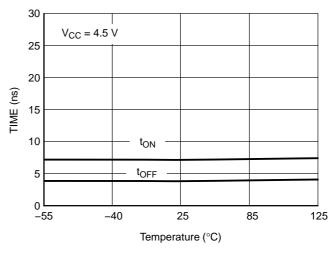
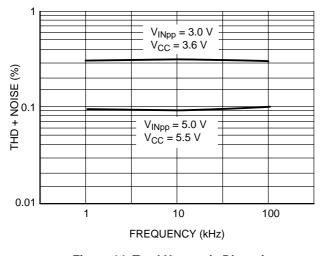


Figure 12. t<sub>ON</sub> and t<sub>OFF</sub> vs. V<sub>CC</sub> at 25°C

Figure 13. t<sub>ON</sub> and t<sub>OFF</sub> vs. Temp



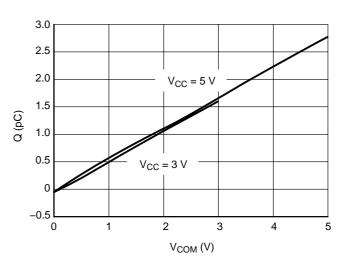
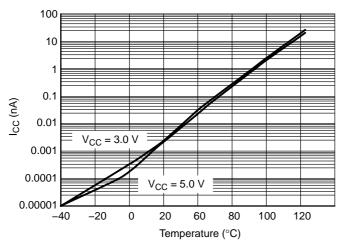


Figure 14. Total Harmonic Distortion Plus Noise vs. Frequency

Figure 15. Charge Injection vs. COM Voltage

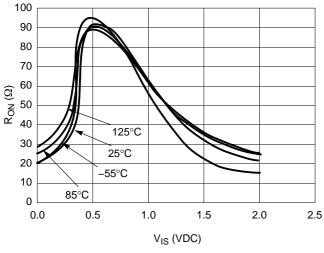
100



 $V_{CC} = 2.0 \text{ V}$ 80 60 Ron (Q)  $V_{CC} = 2.5 \text{ V}$ 40  $V_{CC} = 3.0 \text{ V}$  $V_{CC} = 4.0 \text{ V}$ 20 V<sub>CC</sub> = 5.5 V 0.0 1.0 2.0 3.0 4.0 5.0 6.0 V<sub>IS</sub> (VDC)

Figure 16.  $I_{CC}$  vs. Temp,  $V_{CC}$  = 3 V & 5 V

Figure 17. R<sub>ON</sub> vs. V<sub>CC</sub>, Temp = 25°C



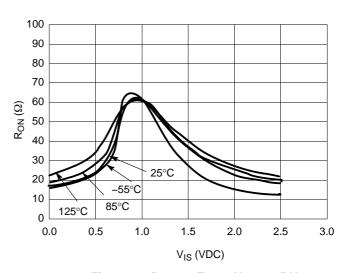
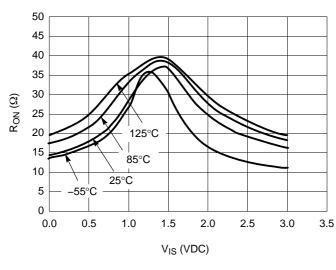


Figure 18.  $R_{ON}$  vs Temp,  $V_{CC} = 2.0 \text{ V}$ 

Figure 19.  $R_{ON}$  vs. Temp,  $V_{CC}$  = 2.5 V



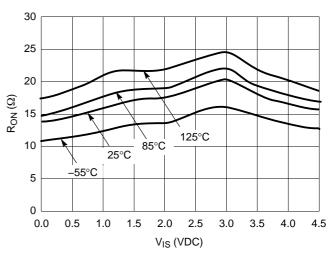


Figure 20.  $R_{ON}$  vs. Temp,  $V_{CC}$  = 3.0 V

Figure 21.  $R_{ON}$  vs. Temp,  $V_{CC}$  = 4.5 V

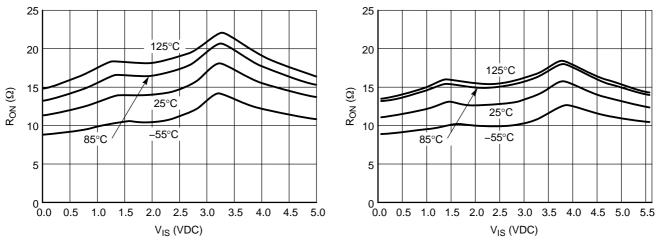


Figure 22.  $R_{ON}$  vs. Temp,  $V_{CC} = 5.0 \text{ V}$ 

Figure 23.  $R_{ON}$  vs. Temp,  $V_{CC} = 5.5 \text{ V}$ 

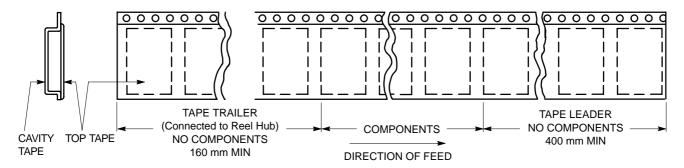


Figure 24. Tape Ends for Finished Goods

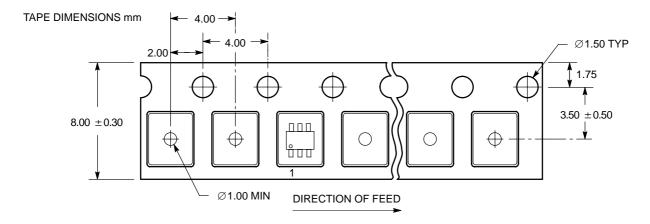


Figure 25. SC70-6/SC-88/SOT-363 DFT2 and SOT23-6/TSOP-6/SC59-6 DTT1 Reel Configuration/Orientation

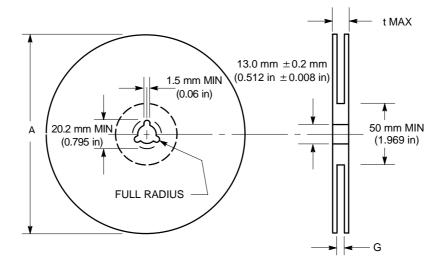


Figure 26. Reel Dimensions

#### **REEL DIMENSIONS**

Tape Size	T and R Suffix	A Max	G	t Max
8 mm	T1, T2	178 mm (7 in)	8.4 mm, + 1.5 mm, -0.0 (0.33 in + 0.059 in, -0.00)	14.4 mm (0.56 in)

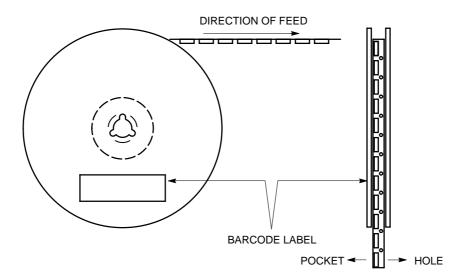
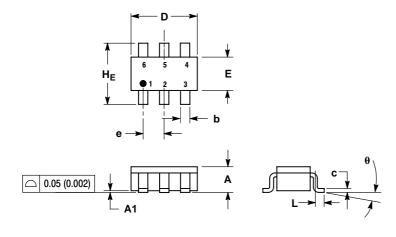


Figure 27. Reel Winding Direction

#### **PACKAGE DIMENSIONS**

#### TSOP-6 CASE 318G-02 **ISSUE S**

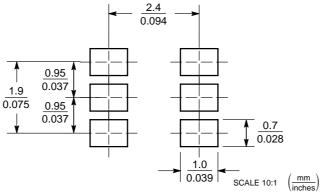


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIA
- I FILANESS IS I HE MINIMUM THICKNESS BASE MATERIAL.

  4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.90	1.00	1.10	0.035	0.039	0.043
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.25	0.38	0.50	0.010	0.014	0.020
С	0.10	0.18	0.26	0.004	0.007	0.010
D	2.90	3.00	3.10	0.114	0.118	0.122
Е	1.30	1.50	1.70	0.051	0.059	0.067
Ф	0.85	0.95	1.05	0.034	0.037	0.041
L	0.20	0.40	0.60	0.008	0.016	0.024
HE	2.50	2.75	3.00	0.099	0.108	0.118
θ	0°	-	10°	0°	-	10°

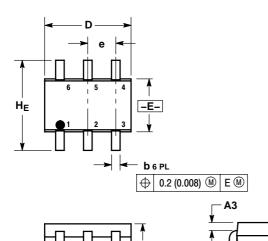
#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### PACKAGE DIMENSIONS

#### SC-88/SC70-6/SOT-363 CASE 419B-02 ISSUE W

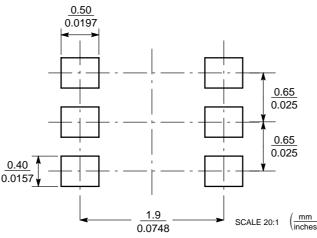


#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
  Y14.5M. 1982.
  - 2. CONTROLLING DIMENSION: INCH.
- 3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	MIL	LIMETE	RS	INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.80	0.95	1.10	0.031	0.037	0.043	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A3		0.20 RE	F	(	0.008 RI	EF	
b	0.10	0.21	0.30	0.004	0.008	0.012	
С	0.10	0.14	0.25	0.004	0.005	0.010	
D	1.80	2.00	2.20	0.070	0.078	0.086	
E	1.15	1.25	1.35	0.045	0.049	0.053	
е	(	0.65 BS	С	0.026 BSC			
L	0.10	0.20	0.30	0.004	0.008	0.012	
HE	2.00	2.10	2.20	0.078	0.082	0.086	

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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